

In addition to part I (General Handout for all courses appended to the time table) this portion gives further specific details regarding the course.

Course No. : **EEE / INSTR F313**

Course Title : **ANALOG AND DIGITAL VLSI DESIGN**

Instructor-in-charge : **Surya Shankar Dan**

Instructors : **Surya Shankar Dan**

1. Scope and Objective of the Course:

The objective of this course is to provide to the student an introduction to the fundamentals and practical considerations pertaining to the design of integrated circuits. The scope encompasses both analog and digital integrated circuits. The importance of CAD tools in IC system design process is also acknowledged and stressed upon.

2. Course Description:

Moore's Law, Y chart, MOS device models including Deep Sub-Micron effects; an overview of fabrication of CMOS circuits, parasitic capacitances, MOS scaling techniques, latch up, matching issues, common centroid geometries in layout. Digital circuit design styles for logic, arithmetic and sequential blocks design; device sizing using logical effort; timing issues (clock skew and jitter) and clock distribution techniques; estimation and minimization of energy consumption; Power delay trade-off, interconnect modelling; memory architectures, memory circuits design, sense amplifiers; an overview of testing of integrated circuits. Basic and cascaded NMOS/PMOS/CMOS gain stages, Differential amplifier and advanced OPAMP design, matching of devices, mismatch analysis, CMRR, PSRR and slew rate issues, offset voltage, advanced current mirrors; current and voltage references design, common mode feedback circuits, Frequency response, stability and noise issues in amplifiers; frequency compensation techniques.

3. Text Book :

T1: Jan M. Rabaey; Anantha Chandrakasan; Borivoje Nikolić, "Digital Integrated Circuits - A Design Perspective", (Second Edition) Prentice-Hall Electronics and VLSI Series. (2003).

T2: Behzad Razavi, "Design of Analog CMOS integrated circuits", McGraw Hill International Edition. 2001.

4. Prime Reference Books

R1: Neil H.E. Weste, David Harris, Ayan Banerjee, "CMOS VLSI Design", 3rd Edition Pearson Education.

Other Reference Books:

Ra) Kang, S.M and Leblebici Y., "CMOS Digital Integrated Circuits: Analysis and Design, McGraw Hill International Editions 3rd Edition 2003.

Rb) Pucknell D.A., Eshraghian K., "Basic VLSI design, systems and circuits", Third edition, Prentice Hall of India Pvt. Ltd.

Rc) Fabricius E.D., "Introduction to VLSI design", McGraw Hill international editions.

Rd) Gregorian R., Temes G.C., "Analog Mos integrated circuits for signal processing", Wiley interscience publication.

Re) Sze S.M., "VLSI Technology", Second edition, McGraw Hill International Edition.

Rf) IEEE Journals of solid state circuits, VLSI system.

Rg) Martin. Ken, "Digital Integrated Circuit Design", Oxford University Press, Inc.

Rh) Johns. David A. and Martin K, "Analog Integrated Circuit Design," John Wiley & Sons. Inc. 2002.

Ri) Michael. L. Bushnell and Vishwani. D. Agrawal, "Essentials Of Electronic Testing For Digital, Memory And Mixed Signal VLSI Circuits. Kluwer Academic Publishers, Third Edition, 2004

5. Notices: All assignments and notices will be announced in class, put up on the CMS

6. Course Plan :

No	Topic To be Covered	Learning Objectives	Chapter in the
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of Lec.			Text Book
	<u>Common Topics</u>		
2	1. Introduction to VLSI Design Methodologies	Moore's Law, Y chart, Quality Metrics of Digital Design. Design flow	Chapter-1 (T1) /Chapter-1 (R1)
5	2. CMOS Technology, Design Rules, MOS Capacitances, Scaling	MOS device models including Deep Sub-Micron effects; parasitic capacitances, MOS scaling techniques, latch up, matching issues, Introduction to layouts and Industry design flow for analog and digital integrated circuits, An overview of fabrication of CMOS circuits. interconnect modelling;	Chapter-2,3,4 (T1) /Chapter-2,3, (4.5) (R1) + Class Notes
	<u>Digital Design I:</u>		
6	3. MOS inverter- Static and switching characteristics, Combinational MOS logic circuits –Static logic	Digital circuit design styles for logic, Combinational blocks design. Device sizing using logical effort;	Chapter-5,6 (T1) /Chapter-4,6 (R1) + Class Notes
5	4. Synchronous system and Sequential circuits design	Synchronous design, timing metrics, Design of flip-flops, Timing issues (clock skew and jitter) and clock distribution techniques;	Chapter-7,10 (T1) /Chapter-7 (R1) + Class Notes
	<u>Analog Design</u>		
6	5. Advanced Current Sources & sinks; Current Reference circuit,	Basic and cascaded NMOS /PMOS /CMOS gain stages. Advanced current mirrors; current and voltage references design.	Chapter-3,4,5 (T2) + Class Notes
6	6. Operational amplifier architectures and Feedback circuits.	Differential amplifier and advanced OPAMP design, matching of devices, mismatch analysis, common mode feedback circuits	Chapter-8,9 (T2) + Class Notes
5	7. Frequency Compensation and Noise	Frequency Response stability and noise issues in amplifiers; frequency compensation techniques.	Chapter-7, 10(T2) + Class Notes
	<u>Digital Design II:</u>		
4	8. Memory Circuits Design	Design of SRAM, DRAM, decoders, sense amplifiers	Chapter-12 (T1) /Chapter - 9 (R1) + Class Notes
2	9. Power and energy	Estimation and minimization of energy consumption; Power delay trade-off.	Chapter- 4 (T1) /Chapter-4 (R1) + Class Notes
3	10. Design verification & test	Verification of functionality, manufacturing defects.	Chapter-12 (R1) + Class Notes

7. Evaluation Scheme :

Component	Duration	Weights	Marks	Date & Time	Nature of Component
Mid Sem	90 min	35%	70	3/10, 1.30 -- 3.00 PM	CB
2 Quizzes	40 min	20%	20+20=40	TBA	OB

Comp. Exam	180 min	45%	90	10/12 FN	CB
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8. **Make up Policy:** Make up will be given only on genuine reasons. Applications for makeup should be given in advance and prior permission should be obtained for Scheduled tests.
9. **Chamber Consultation Hours :** To be announced in class.
10. **Academic Honesty and Integrity Policy:** Academic honesty and integrity are to be maintained by all the students throughout the semester and no type of academic dishonesty is acceptable.

Instructor-In-Charge
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